

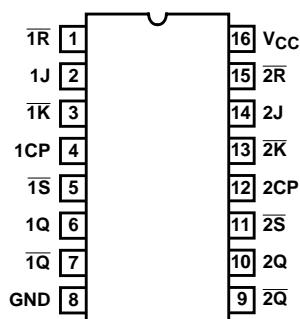
## Dual J-K Flip-Flop with Set and Reset Positive-Edge Trigger

### **Features**

- Asynchronous Set and Reset
- Schmitt Trigger Clock Inputs
- Typical  $f_{MAX} = 54\text{MHz}$  at  $V_{CC} = 5\text{V}$ ,  $C_L = 15\text{pF}$ ,  $T_A = 25^\circ\text{C}$
- Fanout (Over Temperature Range)
  - Standard Outputs ..... 10 LSTTL Loads
  - Bus Driver Outputs ..... 15 LSTTL Loads
- Wide Operating Temperature Range ...  $-55^\circ\text{C}$  to  $125^\circ\text{C}$
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity:  $N_{IL} = 30\%$ ,  $N_{IH} = 30\%$  of  $V_{CC}$  at  $V_{CC} = 5\text{V}$
- HCT Types
  - 4.5V to 5.5V Operation
  - Direct LSTTL Input Logic Compatibility,  $V_{IL} = 0.8\text{V}$  (Max),  $V_{IH} = 2\text{V}$  (Min)
  - CMOS Input Compatibility,  $I_I \leq 1\mu\text{A}$  at  $V_{OL}, V_{OH}$

### **Pinout**

**CD54HC109, CD54HCT109  
(CERDIP)**  
**CD74HC109, CD74HCT109  
(PDIP, SOIC)**  
 TOP VIEW



### **Description**

The 'HC109 and 'HCT109 are dual J-K flip-flops with set and reset. The flip-flop changes state with the positive transition of Clock (1CP and 2CP).

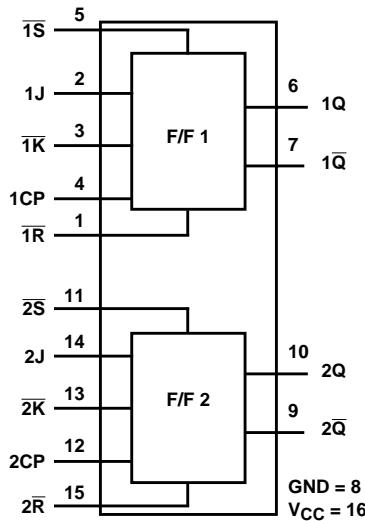
The flip-flop is set and reset by active-low  $\bar{S}$  and  $\bar{R}$ , respectively. A low on both the set and reset inputs simultaneously will force both Q and  $\bar{Q}$  outputs high. However, both set and reset going high simultaneously results in an unpredictable output condition.

### **Ordering Information**

PART NUMBER	TEMP. RANGE (°C)	PACKAGE
CD54HC109F3A	-55 to 125	16 Ld CERDIP
CD54HCT109F3A	-55 to 125	16 Ld CERDIP
CD74HC109E	-55 to 125	16 Ld PDIP
CD74HC109M	-55 to 125	16 Ld SOIC
CD74HC109MT	-55 to 125	16 Ld SOIC
CD74HC109M96	-55 to 125	16 Ld SOIC
CD74HCT109E	-55 to 125	16 Ld PDIP
CD74HCT109M	-55 to 125	16 Ld SOIC
CD74HCT109MT	-55 to 125	16 Ld SOIC
CD74HCT109M96	-55 to 125	16 Ld SOIC

NOTE: When ordering, use the entire part number. The suffix 96 denotes tape and reel. The suffix T denotes a small-quantity reel of 250.

### Functional Diagram



TRUTH TABLE

INPUTS					OUTPUTS	
$\bar{S}$	$\bar{R}$	CP	J	$\bar{K}$	Q	$\bar{Q}$
L	H	X	X	X	H	L
H	L	X	X	X	L	H
L	L	X	X	X	H (Note 1)	H (Note 1)
H	H	↑	L	L	L	H
H	H	↑	H	L	Toggle	
H	H	↑	L	H	No Change	
H	H	↑	H	H	H	L
H	H	L	X	X	No Change	

H= High Level (Steady State)

L= Low Level (Steady State)

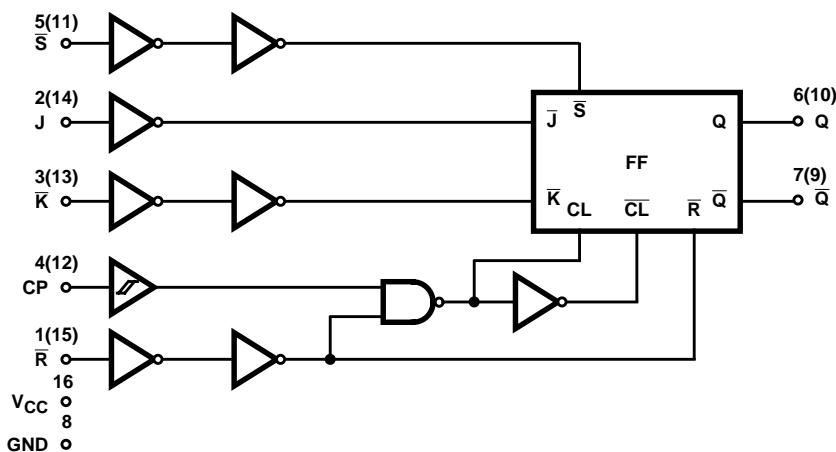
X= Don't Care

↑= Low-to-High Transition

NOTE:

1. Unpredictable and unstable condition if both  $\bar{S}$  and  $\bar{R}$  go high simultaneously

### Logic Diagram



# CD54HC109, CD74HC109, CD54HCT109, CD74HCT109

## Absolute Maximum Ratings

DC Supply Voltage, V <sub>CC</sub>	.....	-0.5V to 7V
DC Input Diode Current, I <sub>IK</sub>		
For V <sub>I</sub> < -0.5V or V <sub>I</sub> > V <sub>CC</sub> + 0.5V	.....	±20mA
DC Drain Current, per Output, I <sub>O</sub>		
For -0.5V < V <sub>O</sub> < V <sub>CC</sub> + 0.5V	.....	±25mA
DC Output Diode Current, I <sub>OK</sub>		
For V <sub>O</sub> < -0.5V or V <sub>O</sub> > V <sub>CC</sub> + 0.5V	.....	±20mA
DC Output Source or Sink Current per Output Pin, I <sub>O</sub>		
For V <sub>O</sub> > -0.5V or V <sub>O</sub> < V <sub>CC</sub> + 0.5V	.....	±25mA
DC V <sub>CC</sub> or Ground Current, I <sub>CC</sub>	.....	±50mA

## Thermal Information

Thermal Resistance (Typical, Note 2)	θ <sub>JA</sub> (°C/W)
E (PDIP) Package	67
M (SOIC) Package	73
Maximum Junction Temperature (Hermetic Package or Die)	175°C
Maximum Junction Temperature (Plastic Package)	150°C
Maximum Storage Temperature Range	-65°C to 150°C
Maximum Lead Temperature (Soldering 10s)	300°C
(SOIC - Lead Tips Only)	

## Operating Conditions

Temperature Range, T <sub>A</sub>	.....	-55°C to 125°C
Supply Voltage Range, V <sub>CC</sub>		
HC Types	.....	.2V to 6V
HCT Types	.....	4.5V to 5.5V
DC Input or Output Voltage, V <sub>I</sub> , V <sub>O</sub>	.....	0V to V <sub>CC</sub>
C <sub>P</sub> Input Rise and Fall Time, t <sub>r</sub> , t <sub>f</sub>		
2V	.....	1.0ms (Max)
4.5V	.....	1.0ms (Max)
6V	.....	1.0ms (Max)
Input Rise and Fall Time (All Inputs Except C <sub>P</sub> ), t <sub>r</sub> , t <sub>f</sub>		
2V	.....	1000ns (Max)
4.5V	.....	500ns (Max)
6V	.....	400ns (Max)

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### NOTE:

- The package thermal impedance is calculated in accordance with JESD 51-7

## DC Electrical Specifications

PARAMETER	SYMBOL	TEST CONDITIONS		V <sub>CC</sub> (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS	
		V <sub>I</sub> (V)	I <sub>O</sub> (mA)		MIN	TYP	MAX	MIN	MAX	MIN	MAX		
<b>HC TYPES</b>													
High Level Input Voltage	V <sub>IH</sub>	-	-	2	1.5	-	-	1.5	-	1.5	-	V	
				4.5	3.15	-	-	3.15	-	3.15	-	V	
				6	4.2	-	-	4.2	-	4.2	-	V	
Low Level Input Voltage	V <sub>IL</sub>	-	-	2	-	-	0.5	-	0.5	-	0.5	V	
				4.5	-	-	1.35	-	1.35	-	1.35	V	
				6	-	-	1.8	-	1.8	-	1.8	V	
High Level Output Voltage CMOS Loads	V <sub>OH</sub>	V <sub>IH</sub> or V <sub>IL</sub>	-0.02	2	1.9	-	-	1.9	-	1.9	-	V	
				4.5	4.4	-	-	4.4	-	4.4	-	V	
				6	5.9	-	-	5.9	-	5.9	-	V	
High Level Output Voltage TTL Loads			-4	-	-	-	-	-	-	-	-	V	
				-4	4.5	3.96	-	-	3.84	-	3.7	-	V
				-5.2	6	5.48	-	-	5.34	-	5.2	-	V

# CD54HC109, CD74HC109, CD54HCT109, CD74HCT109

## DC Electrical Specifications (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS		V <sub>CC</sub> (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
		V <sub>I</sub> (V)	I <sub>O</sub> (mA)		MIN	TYP	MAX	MIN	MAX	MIN	MAX	
Low Level Output Voltage CMOS Loads	V <sub>OL</sub>	V <sub>IH</sub> or V <sub>IL</sub>	0.02	2	-	-	0.1	-	0.1	-	0.1	V
			4.5	-	-	0.1	-	0.1	-	0.1	-	V
			6	-	-	0.1	-	0.1	-	0.1	-	V
		TTL Loads	-	-	-	-	-	-	-	-	-	V
			4	4.5	-	-	0.26	-	0.33	-	0.4	V
			5.2	6	-	-	0.26	-	0.33	-	0.4	V
Input Leakage Current	I <sub>I</sub>	V <sub>CC</sub> or GND	-	6	-	-	±0.1	-	±1	-	±1	µA
Quiescent Device Current	I <sub>CC</sub>	V <sub>CC</sub> or GND	0	6	-	-	4	-	40	-	80	µA
<b>HCT TYPES</b>												
High Level Input Voltage	V <sub>IH</sub>	-	-	4.5 to 5.5	2	-	-	2	-	2	-	V
Low Level Input Voltage	V <sub>IL</sub>	-	-	4.5 to 5.5	-	-	0.8	-	0.8	-	0.8	V
High Level Output Voltage CMOS Loads	V <sub>OH</sub>	V <sub>IH</sub> or V <sub>IL</sub>	-0.02	4.5	4.4	-	-	4.4	-	4.4	-	V
			-4	4.5	3.98	-	-	3.84	-	3.7	-	V
Low Level Output Voltage CMOS Loads	V <sub>OL</sub>	V <sub>IH</sub> or V <sub>IL</sub>	0.02	4.5	-	-	0.1	-	0.1	-	0.1	V
			4	4.5	-	-	0.26	-	0.33	-	0.4	V
Input Leakage Current	I <sub>I</sub>	V <sub>CC</sub> and GND	-	5.5	-	-	±0.1	-	±1	-	±1	µA
Quiescent Device Current	I <sub>CC</sub>	V <sub>CC</sub> or GND	0	5.5	-	-	4	-	40	-	80	µA
Additional Quiescent Device Current Per Input Pin: 1 Unit Load	ΔI <sub>CC</sub> (Note 3)	V <sub>CC</sub> - 2.1	-	4.5 to 5.5	-	100	360	-	450	-	490	µA

NOTE:

3. For dual-supply systems theoretical worst case (V<sub>I</sub> = 2.4V, V<sub>CC</sub> = 5.5V) specification is 1.8mA.

## HCT Input Loading Table

INPUT	UNIT LOADS
All	0.3

NOTE: Unit Load is ΔI<sub>CC</sub> limit specified in DC Electrical Specifications table, e.g., 360µA max at 25°C.

**Prerequisite For Switching Specifications**

PARAMETER	SYMBOL	TEST CONDITIONS	V <sub>CC</sub> (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<b>HC TYPES</b>											
Setup Time J, $\bar{K}$ , to CP	t <sub>SU</sub>	-	2	80	-	-	100	-	120	-	ns
			4.5	16	-	-	20	-	24	-	ns
			6	14	-	-	17	-	20	-	ns
Hold Time J, $\bar{K}$ , to CP	t <sub>H</sub>	-	2	5	-	-	5	-	5	-	ns
			4.5	5	-	-	5	-	5	-	ns
			6	5	-	-	5	-	5	-	ns
Removal Time $\bar{R}$ , $\bar{S}$ , to CP	t <sub>REM</sub>	-	2	80	-	-	100	-	120	-	ns
			4.5	16	-	-	20	-	24	-	ns
			6	14	-	-	17	-	20	-	ns
Pulse Width CP, $\bar{R}$ , $\bar{S}$	t <sub>W</sub>	-	2	80	-	-	100	-	120	-	ns
			4.5	16	-	-	20	-	24	-	ns
			6	14	-	-	17	-	20	-	ns
CP Frequency	f <sub>MAX</sub>	-	2	6	-	-	5	-	4	-	MHz
			4.5	30	-	-	25	-	20	-	MHz
			6	35	-	-	29	-	23	-	MHz
<b>HCT TYPES</b>											
Setup Time J, $\bar{K}$ , to CP	t <sub>SU</sub>	-	4.5	18	-	-	23	-	27	-	ns
Hold Time J, $\bar{K}$ , to CP	t <sub>H</sub>	-	4.5	3	-	-	3	-	3	-	ns
Removal Time $\bar{R}$ , $\bar{S}$ , to CP	t <sub>REM</sub>	-	4.5	18	-	-	23	-	27	-	ns
Pulse Width CP, $\bar{R}$ , $\bar{S}$	t <sub>W</sub>	-	4.5	18	-	-	23	-	27	-	ns
CP Frequency	f <sub>MAX</sub>	-	4.5	27	-	-	22	-	18	-	MHz

**Switching Specifications** Input t<sub>r</sub>, t<sub>f</sub> = 6ns

PARAMETER	SYMBOL	TEST CONDITIONS	V <sub>CC</sub> (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<b>HC TYPES</b>											
Propagation Delay, CP $\rightarrow$ Q, $\bar{Q}$	t <sub>PLH</sub> , t <sub>PHL</sub>	$C_L = 50\text{pF}$	2	-	-	175	-	220	-	265	ns
			4.5	-	-	35	-	44	-	53	ns
			5	-	14	-	-	-	-	-	ns
			6	-	-	30	-	37	-	45	ns
Propagation Delay, $\bar{S} \rightarrow Q$	t <sub>PLH</sub> , t <sub>PHL</sub>	$C_L = 50\text{pF}$	2	-	-	120	-	150	-	180	ns
			4.5	-	-	24	-	30	-	36	ns
			5	-	9	-	-	-	-	-	ns
			6	-	-	20	-	26	-	31	ns
Propagation Delay, $\bar{S} \rightarrow \bar{Q}$	t <sub>PLH</sub> , t <sub>PHL</sub>	$C_L = 50\text{pF}$	2	-	-	155	-	195	-	235	ns
			4.5	-	-	31	-	39	-	47	ns
			5	-	13	-	-	-	-	-	ns
			6	-	-	26	-	33	-	40	ns

# CD54HC109, CD74HC109, CD54HCT109, CD74HCT109

## Switching Specifications Input $t_r, t_f = 6\text{ns}$ (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	V <sub>CC</sub> (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
Propagation Delay, $\bar{R} \rightarrow Q$	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	2	-	-	185	-	230	-	280	ns
		C <sub>L</sub> = 50pF	4.5	-	-	37	-	46	-	56	ns
		C <sub>L</sub> = 15pF	5	-	15	-	-	-	-	-	ns
		C <sub>L</sub> = 50pF	6	-	-	31	-	39	-	48	ns
Propagation Delay, $\bar{R} \rightarrow \bar{Q}$	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	2	-	-	170	-	215	-	255	ns
		C <sub>L</sub> = 50pF	4.5	-	-	34	-	43	-	51	ns
		C <sub>L</sub> = 15pF	5	-	14	-	-	-	-	-	ns
		C <sub>L</sub> = 50pF	6	-	-	29	-	37	-	43	ns
Transition Time	t <sub>TLH</sub> , t <sub>THL</sub>	C <sub>L</sub> = 50pF	2	-	-	75	-	95	-	110	ns
		C <sub>L</sub> = 50pF	4.5	-	-	15	-	19	-	22	ns
		C <sub>L</sub> = 50pF	6	-	-	13	-	16	-	19	ns
Input Capacitance	C <sub>I</sub>	-	-	-	-	10	-	10	-	10	pF
CP Frequency	f <sub>MAX</sub>	C <sub>L</sub> = 15pF	5	-	60	-	-	-	-	-	MHz
Power Dissipation Capacitance (Notes 4, 5)	C <sub>PD</sub>	-	5	-	30	-	-	-	-	-	pF

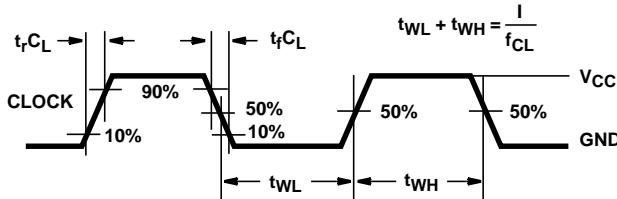
## HCT TYPES

Propagation Delay, CP → Q, $\bar{Q}$	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	4.5	-	-	40	-	50	-	60	ns
		C <sub>L</sub> = 15pF	5	-	17	-	-	-	-	-	ns
Propagation Delay, $\bar{S} \rightarrow Q$	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	4.5	-	-	30	-	38	-	45	ns
		C <sub>L</sub> = 15pF	5	-	12	-	-	-	-	-	ns
Propagation Delay, $\bar{S} \rightarrow \bar{Q}$	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	4.5	-	-	45	-	56	-	68	ns
		C <sub>L</sub> = 15pF	5	-	19	-	-	-	-	-	ns
Propagation Delay, $\bar{R} \rightarrow Q$	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	4.5	-	-	45	-	56	-	68	ns
		C <sub>L</sub> = 15pF	5	-	19	-	-	-	-	-	ns
Propagation Delay, $\bar{R} \rightarrow \bar{Q}$	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	4.5	-	-	37	-	46	-	56	ns
		C <sub>L</sub> = 15pF	5	-	15	-	-	-	-	-	ns
Transition Time (Figure 5)	t <sub>TLH</sub> , t <sub>THL</sub>	C <sub>L</sub> = 50pF	4.5	-	-	15	-	19	-	22	ns
Input Capacitance	C <sub>I</sub>	-	-	-	-	10	-	10	-	10	pF
CP Frequency	f <sub>MAX</sub>	CL = 15pF	5	-	54	-	-	-	-	-	MHz
Power Dissipation Capacitance (Notes 4, 5)	C <sub>PD</sub>	-	5	-	33	-	-	-	-	-	pF

## NOTES:

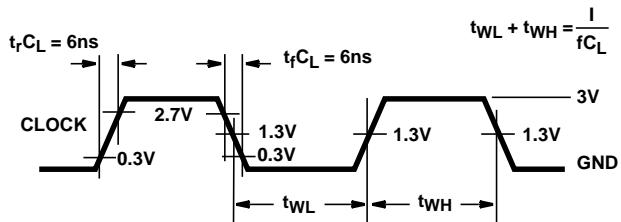
4. C<sub>PD</sub> is used to determine the dynamic power consumption, per flip-flop.
5. P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup> f<sub>i</sub> +  $\sum C_L f_o$  where f<sub>i</sub> = input frequency, f<sub>o</sub> = output frequency, C<sub>L</sub> = output load capacitance, V<sub>CC</sub> = supply voltage.

### Test Circuits and Waveforms



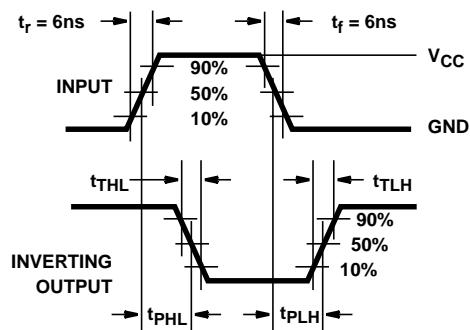
NOTE: Outputs should be switching from 10%  $V_{CC}$  to 90%  $V_{CC}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

**FIGURE 7. HC CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH**

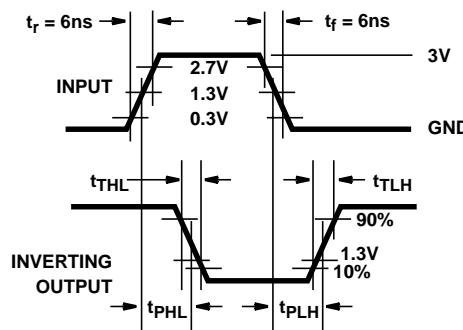


NOTE: Outputs should be switching from 10%  $V_{CC}$  to 90%  $V_{CC}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

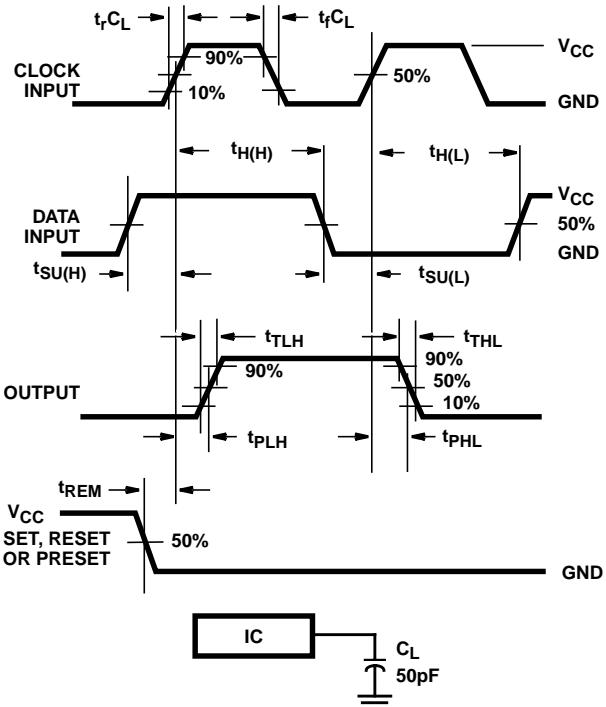
**FIGURE 8. HCT CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH**



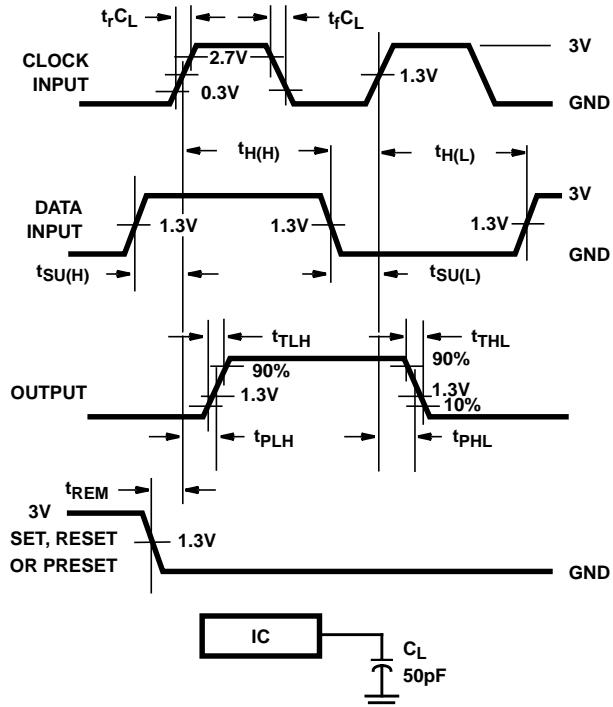
**FIGURE 9. HC AND HCU TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC**



**FIGURE 10. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC**



**FIGURE 11. HC SETUP TIMES, HOLD TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR EDGE TRIGGERED SEQUENTIAL LOGIC CIRCUITS**



**FIGURE 12. HCT SETUP TIMES, HOLD TIMES, REMOVAL TIME, AND PROPAGATION DELAY TIMES FOR EDGE TRIGGERED SEQUENTIAL LOGIC CIRCUITS**